

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	18	(US-20040243266-\$ or US-20020183950-\$ or US-20030093177-\$ or US-20030029383-\$).did. or (US-5963911-\$ or US-6090632-\$ or US-6256548-\$ or US-6272389-\$ or US-6363294-\$ or US-6728588-\$ or US-6842660-\$ or US-6850895-\$ or US-6748282-\$ or US-6567716-\$ or US-6735493-\$ or US-6853873-\$ or US-6766285-\$ or US-6418351-\$). did.	US-PGPUB; USPAT	OR	OFF	2005/03/18 14:17
L4	1	I3 and contaminant\$4	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 14:17
S1	7	US-6349237-\$ DID. OR US-6363294-\$ DID. OR US-6408220-\$ DID. OR US-6415193-\$ DID. OR US-6473664-\$ DID. OR US-6505090-\$ DID. OR US-6546308-\$ DID.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:27
S2	1	"20030069660"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:23
S3	8	S1 or S2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:24
S4	0	"700"/\$.ccls. and substrate adj attribute	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:25
S5	8	substrate adj attribute	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:26
S6	3	S3 and attribute	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:28
S7	10	oca and sca	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:29
S8	69	700/96-100,121.ccls. and accept\$4 and suspend\$2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:28
S9	10	S8 and attribute	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:30
S10	6	700/96-100,121.ccls. and metrology and suspend\$2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 13:41

S11	7	("6363294").URPN.	USPAT	OR	OFF	2005/03/17 13:55
S12	11	("4901242"   "5210041"   "5483636"   "5511005"   "5625816"   "5654903"   "5787190"   "5859964"   "6090632"   "6185511"   "6192291").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/17 14:05
S13	22	700/96-100,121.ccls. and compatib\$5 and suspend\$2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:07
S14	23	("5963911").URPN.	USPAT	OR	OFF	2005/03/17 14:08
S15	6	("5375061"   "5757648"   "5818716"   "5841677"   "5880960"   "5963911").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/17 14:11
S16	314	"700"/\$.ccls. and compatib\$5 and suspend\$2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:13
S17	0	S16 and dispatch same lots	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:13
S18	0	S16 and dispatch and lots	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:13
S19	23	S16 and dispatch	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:13
S20	22	"700"/\$.ccls. and product same compatible same operation	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:25
S21	983	product same compatible same operation	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:25
S22	81	S21 and manufactur\$4 and tool	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:26
S23	2	S22 and dispatch	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:26
S24	4	S22 and suspend	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:27
S25	45	S21 and suspend	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:27
S26	50	700/121.ccls. and suspend\$2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/17 14:29
S27	5851	semiconductor and compatib\$5 and suspend\$2	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:07

S28	10	S27 and feed-forward	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:07
S29	63	S27 and "700"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:09
S30	13	S29 and (contaminants or contamination)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:10
S31	159	700/121.ccls. and (contaminants or contamination)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:21
S32	26	S31 and compatib\$5	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:10
S33	3	("6520727"   "6599368"   "6638860").PN. OR ("6748282").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 10:15
S34	0	("6567716").URPN.	USPAT	OR	OFF	2005/03/18 10:19
S35	4	("4974166"   "5443346"   "5694325"   "6078845").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 10:19
S36	5	700/121.ccls. and dispatch.ti.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:22
S37	1	700/121.ccls. and compatibility adj violation	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:23
S38	1	700/100.ccls. and compatibility adj violation	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:23
S39	2	compatibility adj violation	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:23
S40	22	"700"/\$.ccls. and operation same product same compatible	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:13
S41	6	"700"/\$.ccls. and wafer same lot same compatible	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:32
S42	15	wafer same lot same compatible	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:31
S43	9	S42 not S41	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:31
S44	240	wafer same compatible same operation	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:33

S45	7	S44 and "700"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 10:33
S46	11	(US-20040243266-\$).did. or (US-5963911-\$ or US-6090632-\$ or US-6256548-\$ or US-6272389-\$ or US-6363294-\$ or US-6728588-\$ or US-6842660-\$ or US-6850895-\$ or US-6748282-\$ or US-6567716-\$). did.	US-PGPUB; USPAT	OR	OFF	2005/03/18 11:02
S47	0	S46 and semiconductor	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:02
S48	8	S46 and semiconductor	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:02
S49	25	"700"/\$.ccls. and match same tool same wafer	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:14
S50	0	("6735493").URPN.	USPAT	OR	OFF	2005/03/18 11:19
S51	9	("20020183950"   "20030204281"   "5761064"   "5896294"   "6035293"   "6165805"   "6185474"   "6415193"   "6465263").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 11:19
S52	5	("5612886"   "5818716"   "5838565"   "5841677"   "5930137").PN. OR ("6594536"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 11:27
S53	300	700/99.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 11:27
S54	115	S53 and (wafer or semiconductor)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 11:28
S55	29	S54 and (compatib\$5 or match)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 11:28
S56	5	("5612886"   "5818716"   "5838565"   "5841677"   "5930137").PN. OR ("6594536"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/18 11:31
S57	40	"700"/\$.ccls. and (wafer or semiconductor) and (throughput same capability)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:43
S58	16	S57 and (stop or suspend)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:37
S59	52	"700"/\$.ccls. and (wafer or semiconductor) and tool near5 capability	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:49

S60	5	wafer adj compatibility	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:53
S61	164	wafer near5 compatibility	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:50
S62	6	S61 and "700"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 11:50
S63	29	tool adj compatibility	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 12:00
S64	122	wafer same compatible same tool	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 12:00
S65	7	S64 and "700"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/18 12:01